54AC16245, 74AC16245 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SCAS235A - MARCH 1990 - REVISED APRIL 1996

Members of the Texas Instruments 54AC16245 . . . WD PACKAGE Widebus[™] Family 74AC16245 ... DGG OR DL PACKAGE (TOP VIEW) 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers Flow-Through Architecture Optimizes PCB Layout Distributed V_{CC} and GND Configuration (Minimizes High-Speed Switching Noise **EPIC**[™] (Enhanced-Performance Implanted CMOS) 1-µm Process 500-mA Typical Latch-Up Immunity at 125°C **Package Options Include Plastic Thin** (Shrink Small-Outline (DGG) Package, 300-mil Shrink Small-Outline (DL) Package Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Pin (**Spacings** description The 'AC16245 are 16-bit bus transceivers organized as dual-octal noninverting 3-state

transceivers designed for asynchronous two-way communication between data buses. The control function implementation minimizes external timing requirements

These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending upon the logic level at the direction control (DIR) input. The output-enable input (OE) can be used to disable the devices so that the buses are effectively isolated.

The 74AC16245 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The 54AC16245 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74AC16245 is characterized for operation from -40°C to 85°C.

_		FUNC	TION TABLE
		TROL UTS	OPERATION
	OE	DIR	
	L	L	B data to A bus
	L	Н	A data to bus
	Н	Х	Isolation



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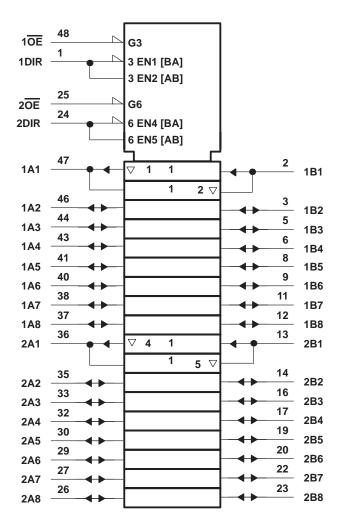


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	(10		EW)
1DIR		\Box	48	
1B1	-		-	
1B2	2		47	1 1A2
	3		46	2
GND	4		45	GND
1B3	5		44	1A3
1B4	6		43	1A4
V _{CC}	7		42	Vcc
1B5	8		41] 1A5
1B6	9		40] 1A6
GND	1	C	39] GND
1B7	11	1	38	1A7
1B8	12	2	37	1A8
2B1	1:	3	36	2A1
2B2	1 14	4	35	1 2A2
GND	H 1!	5	34	
2B3	1	6	33	1 2A3
2B4	H 13	7	32	1 2A4
	H 18	3	31	6
V _{CC} 2B5	H 19	9	30	UV _{CC} 2A5
-			29	6
2B6			28	
GND			27	GND
2B7			26	2A7
2B8			20 25	2 <u>A8</u>
2DIR	42'	+	25	20E
	L			

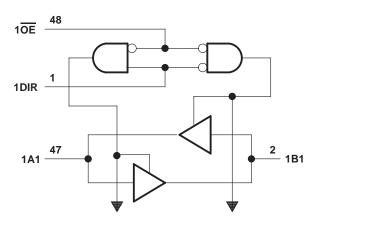
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logic symbol[†]

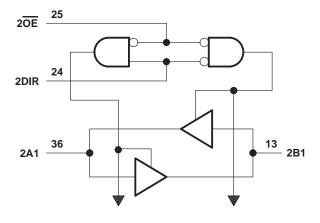


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



To Seven Other Transceivers



To Seven Other Transceivers



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} Input voltage range, V_I (see Note 1) Output voltage range, V_O (see Note 1)	. –0.5 V to V _{CC} + 0.5 V . –0.5 V to V _{CC} + 0.5 V
Input clamp current, I_{IK} (V _I < 0 or V _I > V _{CC})	
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	
Continuous current through V _{CC} or GND	
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2): DGG package	0.85 W
DL package	1.2 W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

recommended operating conditions (see Note 3)

			54	4AC1624	5	74	AC1624	5	LINUT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage (see Note 4)		3	5	5.5	3	5	5.5	V
		$V_{CC} = 3 V$	2.1			2.1			
VIH	High-level input voltage	$V_{CC} = 4.5 V$	3.15			3.15			V
		$V_{CC} = 5.5 V$	3.85			3.85			
		$V_{CC} = 3 V$			0.9			0.9	
VIL	Low-level input voltage	V _{CC} = 4.5 V		1	1.35			1.35	V
		V _{CC} = 5.5 V		2EI	1.65			1.65	
VI	Input voltage		0	2	VCC	0		VCC	V
VO	Output voltage		0	5	VCC	0		VCC	V
		$V_{CC} = 3 V$	ć	2	-4			-4	
ЮН	High-level output current	V _{CC} = 4.5 V	4		-24			-24	mA
		V _{CC} = 5.5 V			-24			-24	
		V _{CC} = 3 V			12			12	
IOL	Low-level output current	V _{CC} = 4.5 V			24			24	mA
		V _{CC} = 5.5 V			24			24	
$\Delta t / \Delta v$	Input transition rise or fall rate	•	0		10	0		10	ns/V
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTES: 3. All unused pins (input and I/O) must be held high or low to prevent them from floating.

4. All V_{CC} and GND pins must be connected to the proper voltage power supply.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS	Mara	T,	₄ = 25°C	;	54AC1	6245	74AC1	6245	
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
		3 V	2.9			2.9		2.9		
	I _{OH} = -50 μA	4.5 V	4.4			4.4		4.4		
		5.5 V	5.4			5.4		5.4		
Vон	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		2.48		V
	1au - 24 mA	4.5 V	3.94			3.8		3.8		
	I _{OH} = -24 mA	5.5 V	4.94			4.8		4.8		
	I _{OH} = -75 mA [†]	5.5 V				3.85	EN	3.85		
		3 V			0.1		0.1		0.1	
	I _{OL} = 50 μA	4.5 V			0.1		0.1		0.1	
		5.5 V			0.1	Ċ)	0.1		0.1	
VOL	I _{OL} = 12 mA	3 V			0.36	la	0.44		0.44	V
	$l_{\alpha} = 24 \text{ mA}$	4.5 V			0.36	40	0.44		0.44	
	I _{OL} = 24 mA	5.5 V			0.36		0.44		0.44	
	I _{OL} = 75 mA [†]	5.5 V					1.65		1.65	
lj	$V_{I} = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μΑ
I _{OZ}	$V_{I} = V_{CC}$ or GND	5.5 V			±0.5		±5		±5	μA
ICC	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			8		80		80	μA
Ci	$V_{I} = V_{CC}$ or GND	5 V		4.5						۳E
Co	$V_{I} = V_{CC}$ or GND	5 V		16						pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

[‡] For I/O ports, the parameter I_{OZ} includes the input leakage current.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (see Figure 1)

PARAMETER	FROM	то	T _A = 25°C			54AC	16245	74AC1	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	A or B	B or A	2.5	7.6	10.4	2.5	11.9	2.5	11.9	ns
^t PHL	AOID	BOIA	3.1	9	12.3	3.1	13.5	3.1	13.5	115
^t PZH	OE	A or B	2.8	8.6	11.8	2.8	13.2	2.8	13.2	-
^t PZL	ÛE	AUB	3.9	12	16.2	3.9	18	3.9	18	ns
^t PHZ	ŌĒ	A or B	5.3	8.4	10.4	5.3	11.2	5.3	11.2	-
^t PLZ	UE	AUIB	4.4	7.7	9.7	2 4.4	10.3	4.4	10.3	ns

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 5 \ V \pm 0.5 \ V$ (see Figure 1)

PARAMETER	FROM	то	Т	Δ = 25°C	;	54AC1	6245	74AC1	6245	UNIT
FARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	A or B	B or A	2	4.6	6.9	2	7.9	2	7.9	ns
^t PHL	AOID	BOIA	2.5	5.2	7.9	2.5	8.9	2.5	8.9	115
^t PZH	OE	A or B	2.3	4.9	7.5	2.3	8.6	2.3	8.6	20
^t PZL	ÛE	AUB	3	6.2	9.5	(w)	10.7	3	10.7	ns
^t PHZ	ŌĒ	A or B	5	7.2	9.1	05	9.8	5	9.8	ns
^t PLZ	UE	AUD	4.2	6.2	8.1	4 .2	8.7	4.2	8.7	115

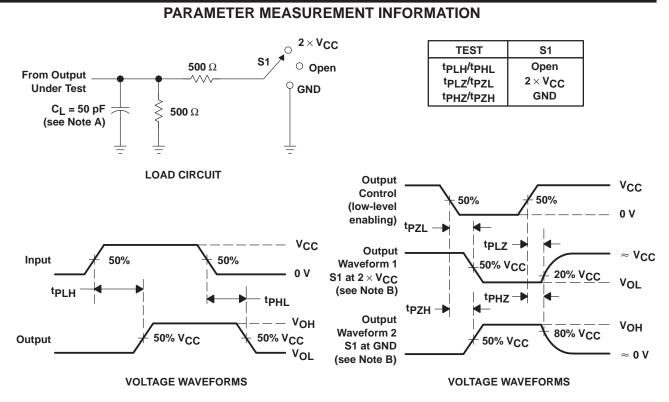
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operating characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT	
<u> </u>	Dower dissinction conscitutes not later	Outputs enabled	Cı = 50 pF. f = 1 MHz	43	~F
Cpd	Power dissipation capacitance per latch	Outputs disabled	C _L = 50 pF, f = 1 MHz	8	р⊦



- NOTES: A. CI includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_Q = 50 Ω , t_f = 3 ns, t_f = 3 ns.
 - D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
74AC16245DLR	ACTIVE	SSOP	DL	48	1000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AC16245	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	
r	

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
74AC16245DLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1



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PACKAGE MATERIALS INFORMATION

16-Apr-2024



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
74AC16245DLR	SSOP	DL	48	1000	367.0	367.0	55.0

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